# LNJ107W5PRW

# Surface Mounting Chip LED

S-GW-2 Type

## ■ Absolute Maximum Ratings $T_a = 25$ °C

#### • Yellow Green

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	60	mW	
Forward current	$I_{F}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

#### • Red

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	60	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	3	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

### ■ Electro-Optical Characteristics $T_a = 25$ °C

#### • Yellow Green

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 10 \text{ mA}$	3.0	5.0		mcd
Reverse current	$I_R$	$V_R = 4 V$			10	μΑ
Forward voltage	$V_{\mathrm{F}}$	$I_F = 10 \text{ mA}$		2.03	2.6	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		565		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		30		nm

### ■ Lighting Color

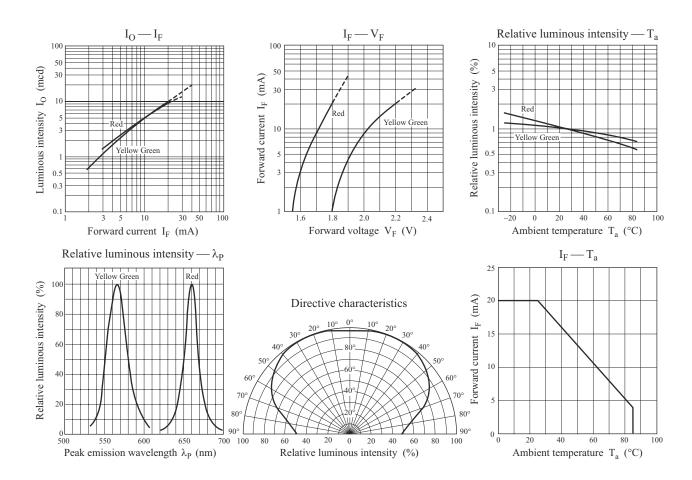
- Yellow Green
- Red

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## ■ Electro-Optical Characteristics (Continued) $T_a = 25$ °C

#### • Red

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_F = 10 \text{ mA}$	1.7	5.0		mcd
Reverse current	$I_R$	$V_R = 3 V$			100	μΑ
Forward voltage	$V_{\mathrm{F}}$	$I_F = 10 \text{ mA}$		1.72	2.5	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		660		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		20		nm

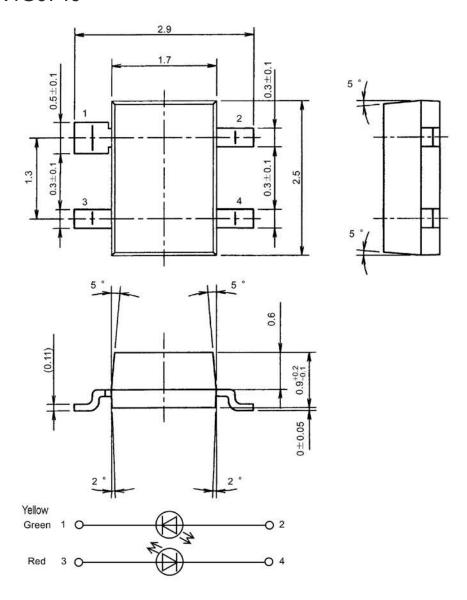


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Panasonic LNJ107W5PRW

■ Package (Unit: mm)

# LLTFTN4G0740



- Pin name
  - 1, 4: Cathode
  - 2, 3: Anode

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